

ZXTP25040DFLTA Datasheet



DiGi Electronics Part Number	ZXTP25040DFLTA-DG
Manufacturer	Diodes Incorporated
Manufacturer Product Number	ZXTP25040DFLTA
Description	TRANS PNP 40V 1.5A SOT23-3
Detailed Description	Bipolar (BJT) Transistor PNP 40 V 1.5 A 270MHz 350 mW Surface Mount SOT-23-3

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
ZXTP25040DFLTA	Diodes Incorporated
Series:	Product Status:
	Active
Transistor Type:	Current - Collector (Ic) (Max):
PNP	1.5 A
Voltage - Collector Emitter Breakdown (Max):	Vce Saturation (Max) @ lb, lc:
40 V	300mV @ 300mA, 3A
Current - Collector Cutoff (Max):	DC Current Gain (hFE) (Min) @ lc, Vce:
50nA (ICBO)	300 @ 10mA, 2V
Power - Max:	Frequency - Transition:
350 mW	270MHz
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Package / Case:	Supplier Device Package:
TO-236-3, SC-59, SOT-23-3	SOT-23-3
Base Product Number:	
ZXTP25040	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.21.0075	







A Product Line of Diodes Incorporated



ZXTP25040DFL

40V PNP LOW POWER TRANSISTOR IN SOT23

Features

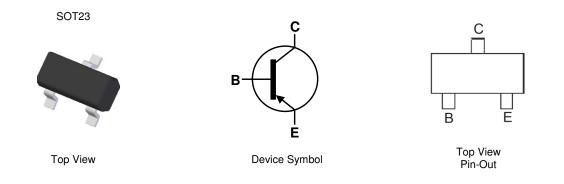
- BV_{CEO} > -40V
- BV_{ECO} > --3V
- I_C = -1.5A Continuous Collector Current
- V_{CE(sat)} < -115mV @ -1A
- R_{CE(sat)} = 82mΩ
- High Peak Current
- Complementary Part Number ZXTN25040DFL
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.008 grams (Approximate)

Applications

- MOSFET and IGBT Gate Driving
- DC-DC Converters



Ordering Information (Note 4)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTP25040DFLTA	1A2	7	8	3,000

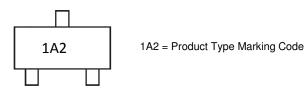
Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

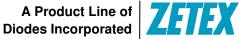
3. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information







Absolute Maximum Ratings (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CBO}	-45	V
Collector-Emitter Voltage (Forward Blocking)	V _{CEO}	-40	V
Emitter-collector voltage (Reverse Blocking)	V _{ECO}	-3	V
Emitter-Base Voltage	V _{EBO}	-7	V
Continuous Collector Current (Note 5)	lc	-1.5	A
Base Current	IB	-500	mA
Peak Pulse Current	I _{CM}	-5	А

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 5)	р	310	mW
Fower Dissipation	(Note 6)	P _D	350	11177
The sum of Designation of American	(Note 5)	D	403	°C/W
Thermal Resistance, Junction to Ambient	(Note 6)	R _{eja}	357	-C/VV
Thermal Resistance, Junction to Leads	(Note 7)	R _{0JL}	350	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +150	°C

ESD Ratings (Note 8)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

Notes: 5. For a device mounted on minimum recommended pad layout 1oz copper that is on a single-sided FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

6. Same as Note 5, except the device is mounted on 15 mm x 15mm 1oz copper.

Thermal resistance from junction to solder-point (at the end of the leads).
Refer to JEDEC specification JESD22-A114 and JESD22-A115.

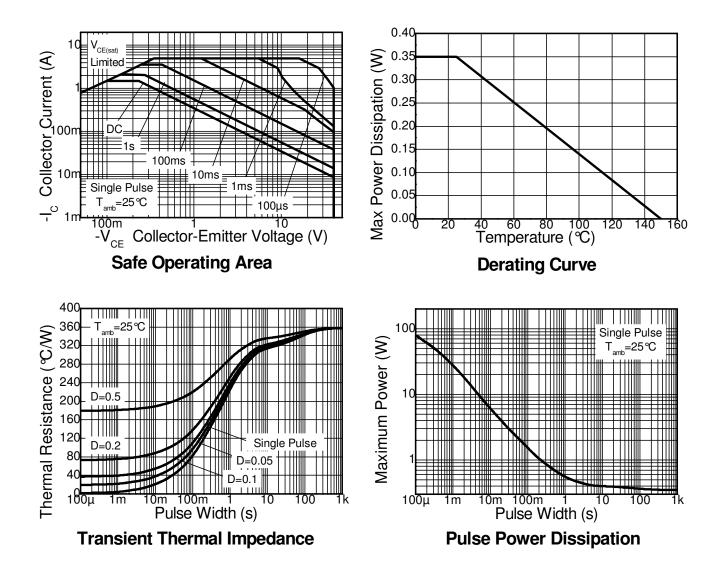


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ZXTP25040DFL

Thermal Characteristics and Derating Information







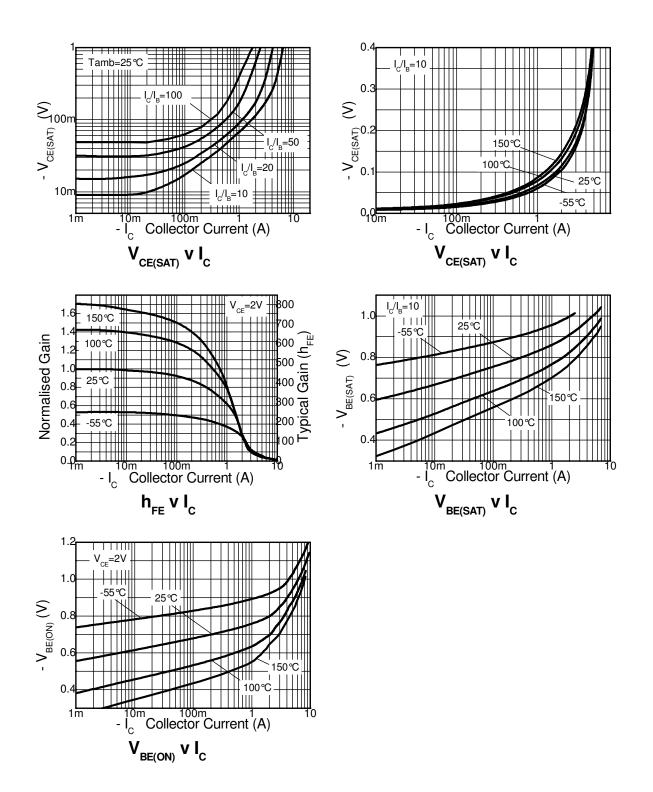
Electrical Characteristics (@T _A = +25 °C, unless otherwise specified.)						
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV _{CBO}	-45	-75	-	V	I _C = -100μA
Collector-Emitter Breakdown Voltage (Note 9)	BV _{CEO}	-40	-65	-	V	I _C = -10mA
Emitter-Base Breakdown Voltage	BV _{EBO}	-7	-8.2	-	V	I _E = -100μA
Emitter-Base Breakdown Voltage	BV _{ECO}	-3	-8.7	-	V	I _E = -100μA
Collector-Base Cutoff Current	1	-	< -1	-50	nA	V _{CB} = -36V
Collector-Base Cuton Current	I _{CBO}	-	-	-20	μA	V _{CB} = -36V, T _{amb} = +100 ℃
Emitter-Base Cutoff Current	I _{EBO}	-	< -1	-50	nA	V _{EB} = -5.6V
		300	450	900		I _C = -10mA, V _{CE} = -2V
Static Forward Current Transfer Ratio (Note 9)	b	120	200	-		I _C = -1.5A, V _{CE} = -2V
	h _{FE}	15	40	-	-	$I_C = -3A, V_{CE} = -2V$
		-	-75	-95		I _C = -0.5A, I _B = -20mA
		-	-200	-290		$I_{C} = -1A, I_{B} = -20mA$
Collector-Emitter Saturation Voltage (Note 9)	V _{CE(sat)}	-	-95	-115	mV	$I_{C} = -1A, I_{B} = -100mA$
		-	-160	-190		I _C = -1.5A, I _B = -75mA
		-	-245	-300		$I_{C} = -3A, I_{B} = -300mA$
Base-Emitter Saturation Voltage (Note 9)	V _{BE(sat)}	-	-915	-1000	mV	$I_{C} = -1.5A, I_{B} = -75mA$
Base-Emitter Saturation Voltage (Note 9)	V _{BE(on)}	-	-825	-900	mV	$I_{C} = -1.5A, V_{CE} = -2V$
Output Capacitance	C _{obo}	-	17.4	25	pF	$V_{CB} = -10V, f = 1MHz$
Transition Frequency	f⊤	-	270	-	MHz	$V_{CE} = -10V$, $I_C = -50mA$, f = 50MHz
Delay Time	t _(d)	-	34	-	ns	
Rise Time	t _(r)	-	41	-	ns	V _{CC} = -15V, I _C = -750mA,
Storage Time	t _(s)	-	266	-	ns	$I_{B1} = -I_{B2} = -15mA$
Fall Time	t _(f)	-	53	-	ns	

Notes: 9. Measured under pulsed conditions. Pulse width \leq 300 µs. Duty cycle \leq 2%.





Typical Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

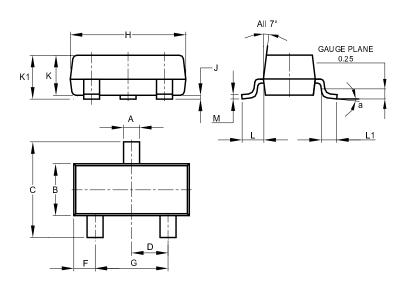






Package Outline Dimensions

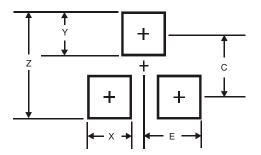
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	SOT23						
Dim	Min	Max	Тур				
Α	0.37	0.51	0.40				
В	1.20	1.40	1.30				
С	2.30	2.50	2.40				
D	0.89	1.03	0.915				
F	0.45	0.60	0.535				
G	1.78	2.05	1.83				
Н	2.80	3.00	2.90				
J	0.013	0.10	0.05				
К	0.890	1.00	0.975				
K1	0.903	1.10	1.025				
L	0.45	0.61	0.55				
L1	0.25	0.55	0.40				
М	0.085	0.150	0.110				
а	8°						
All	Dimens	ions in	mm				

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)			
Z	2.9			
Х	0.8			
Y	0.9			
С	2.0			
E	1.35			





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